

# Device Modeling Report

COMPONENTS: Silicon Carbide Schottky Diode  
PART NUMBER: SCS110AG\_125C  
MANUFACTURER: ROHM  
REMARK: Standard Model

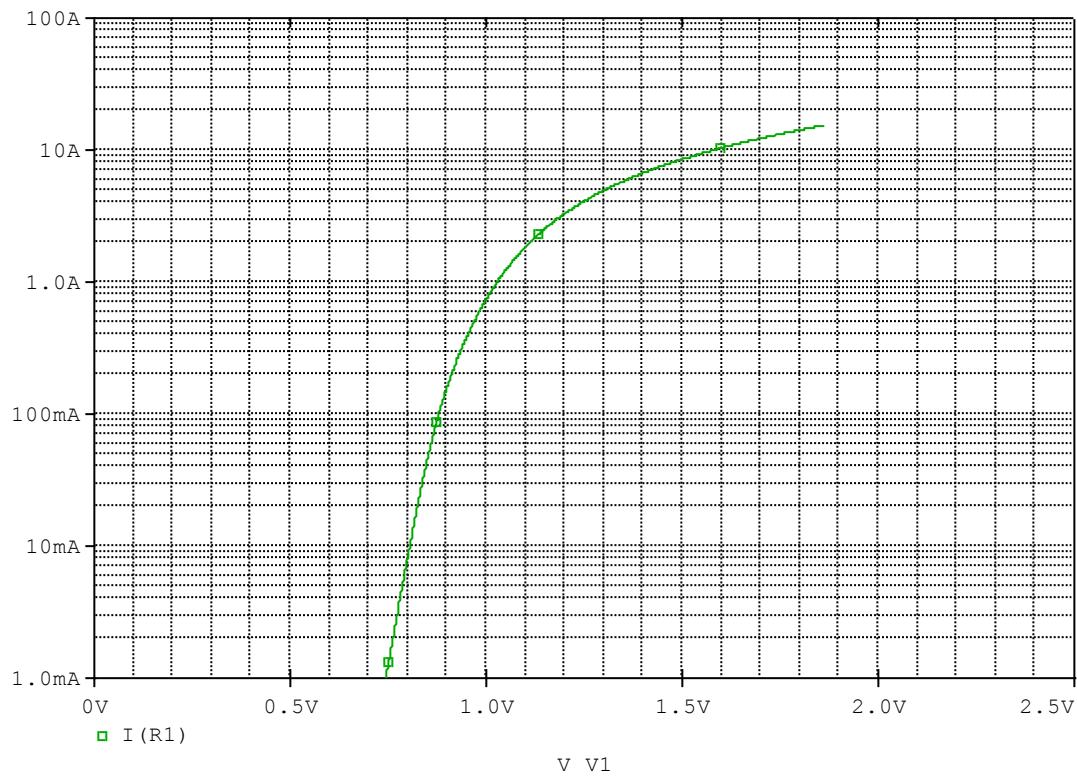


**Bee Technologies Inc.**

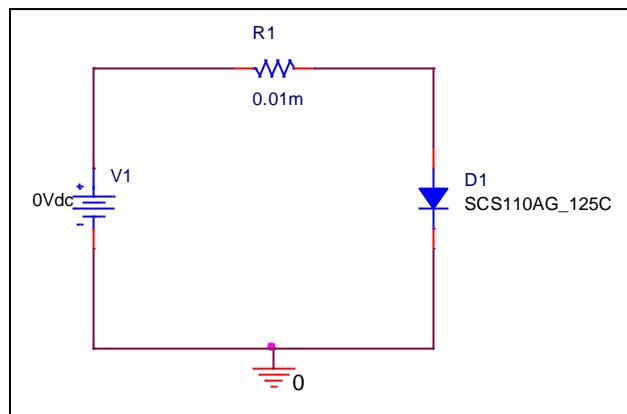
PSpice model parameter	Model description
IS	Saturation Current
N	Emission Coefficient
RS	Series Resistance
IKF	High-injection Knee Current
CJO	Zero-bias Junction Capacitance
M	Junction Grading Coefficient
VJ	Junction Potential
ISR	Recombination Current Saturation Value
BV	Reverse Breakdown Voltage(a positive value)
IBV	Reverse Breakdown Current(a positive value)
TT	Transit Time
EG	Energy-band Gap

## Forward Current Characteristic

### Circuit Simulation Result

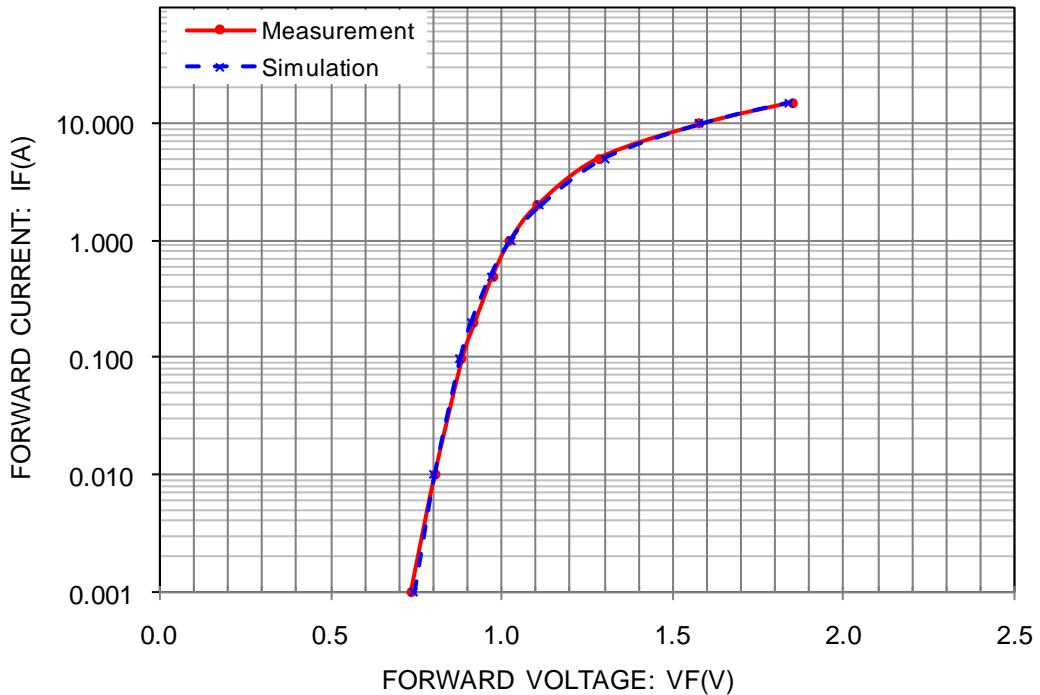


### Evaluation Circuit



## Comparison Graph

Circuit Simulation Result

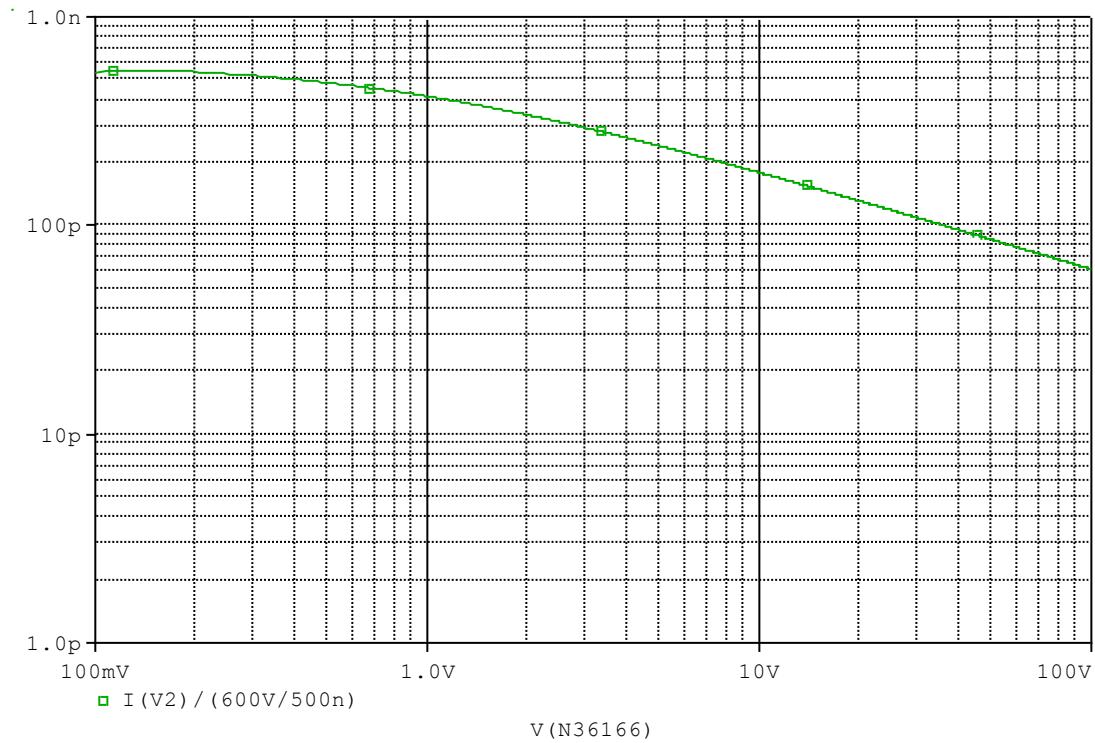


Simulation Result

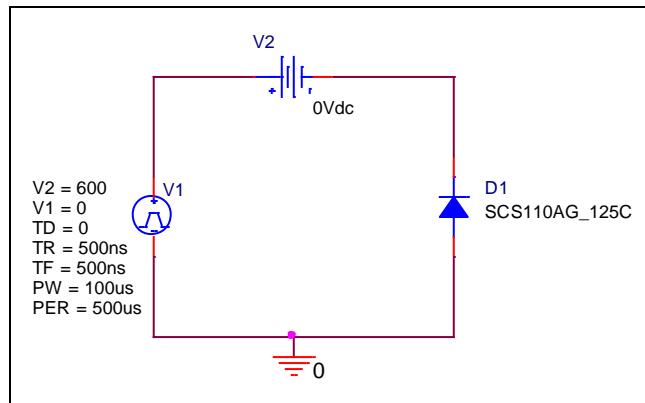
$I_F$ (A)	$V_F$ (V)		Error (%)
	Measurement	Simulation	
0.001	0.7350	0.7436	1.18
0.01	0.8050	0.8047	-0.04
0.1	0.8850	0.8788	-0.70
0.2	0.9200	0.9112	-0.96
0.5	0.9750	0.9686	-0.66
1	1.0250	1.0276	0.25
2	1.1050	1.1114	0.58
5	1.2850	1.3032	1.42
10	1.5800	1.5798	-0.01
15	1.8500	1.8416	-0.45

## Junction Capacitance Characteristic

### Circuit Simulation Result

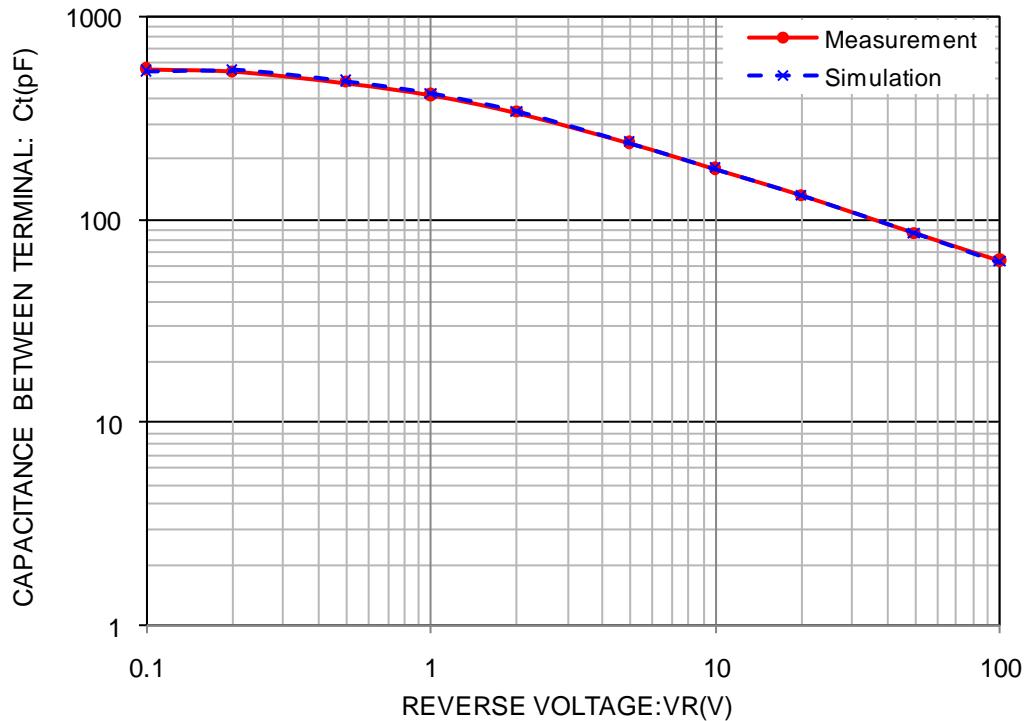


### Evaluation Circuit



## Comparison Graph

Circuit Simulation Result

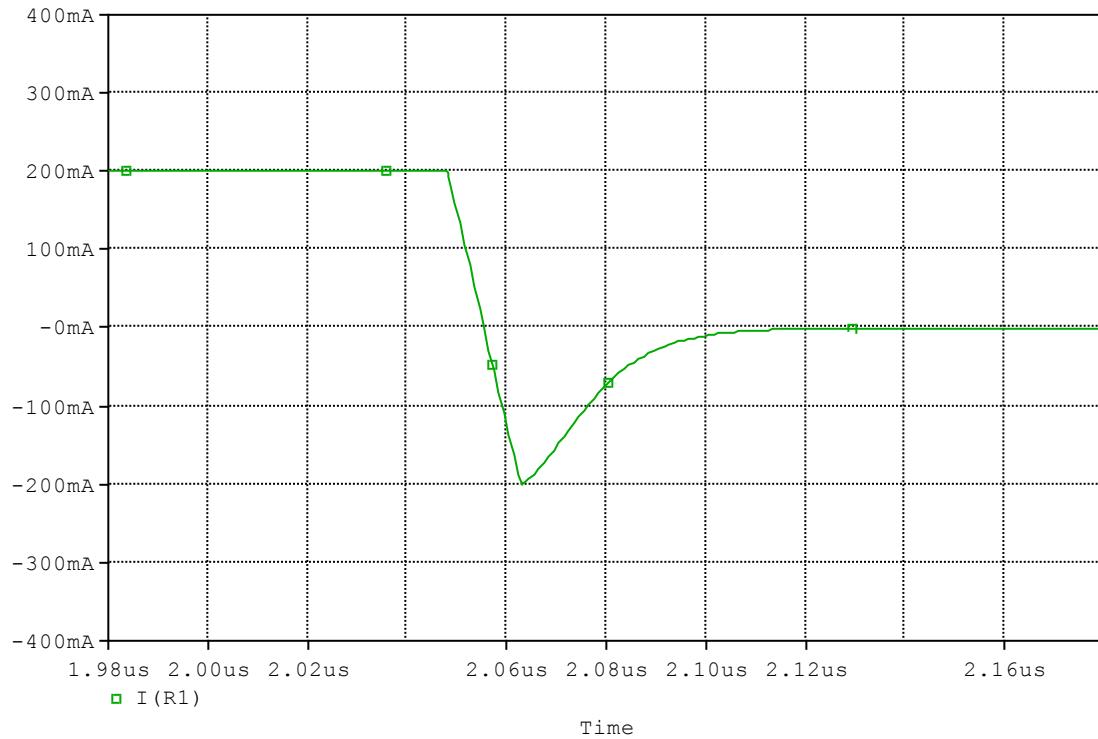


Simulation Result

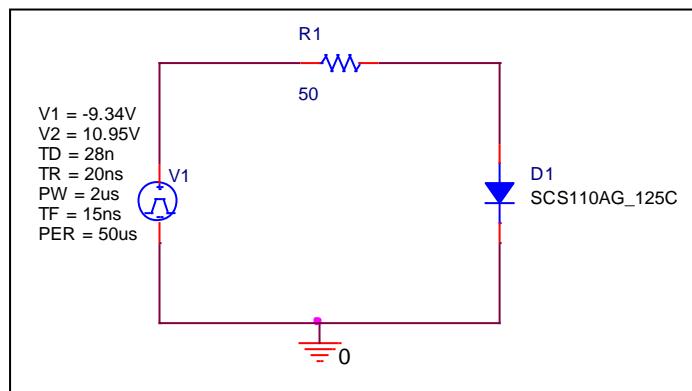
VR(V)	C (pF)		Error (%)
	Measurement	Simulation	
0.1	551.372	542.429	-1.62
0.2	535.162	544.659	1.77
0.5	475.224	483.584	1.76
1	411.432	416.135	1.14
2	337.924	339.050	0.33
5	239.767	240.841	0.45
10	178.669	179.458	0.44
20	131.457	131.401	-0.04
50	85.266	85.651	0.45
100	62.800	61.684	-1.78

## Reverse Recovery Characteristic

### Circuit Simulation Result



### Evaluation Circuit

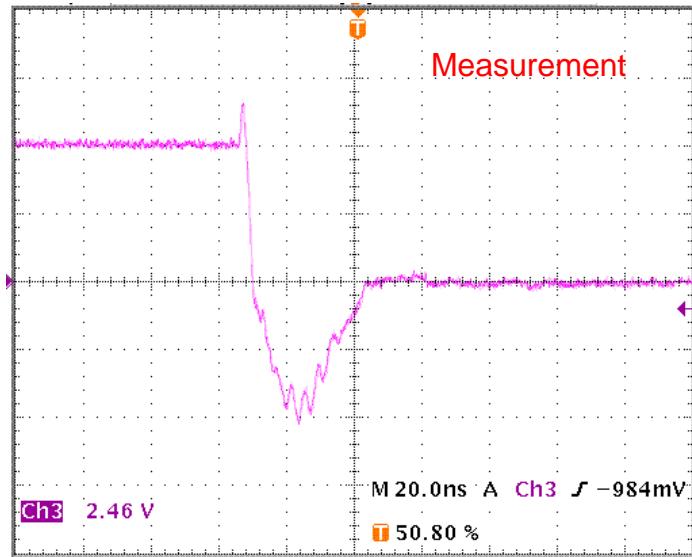


### Compare Measurement vs. Simulation

		Measurement	Simulation	Error (%)
trj	ns	7.500	7.534	0.45

## Reverse Recovery Characteristic

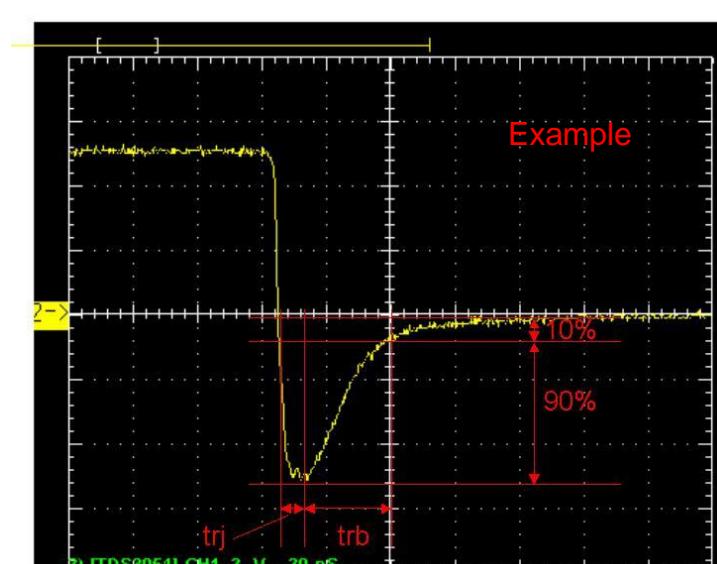
## Reference



Trj = 7.5(ns)

Trb=16.00(ns)

Conditions: Ifwd=0.2A, Irev=0.2A, RI=50Ω



Relation between trj and trb